

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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APPROVAL SHEET

RFBPF Series – 3225(1210)- RoHS Compliance

MULTILAYER CERAMIC BAND PASS FILTER

Halogens Free Product

1125~1675MHz Band Application

P/N: RFBPF3225180C07B1U

*Contents in this sheet are subject to change without prior notice.

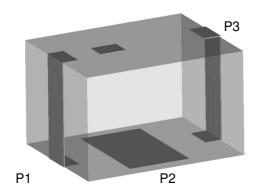
FEATURES

- 1. Miniature footprint: 3.2 X 2.5 X 1.8 mm³
- 2. Low Insertion Loss
- 3. High Rejection at 1002MHz
- 4. LTCC process

APPLICATIONS

1. 1125 ~ 1675 MHz Band applications

CONSTRUCTION



PIN	Connection		
1	Input port		
2	GND		
3	Output port		

DIMENSIONS

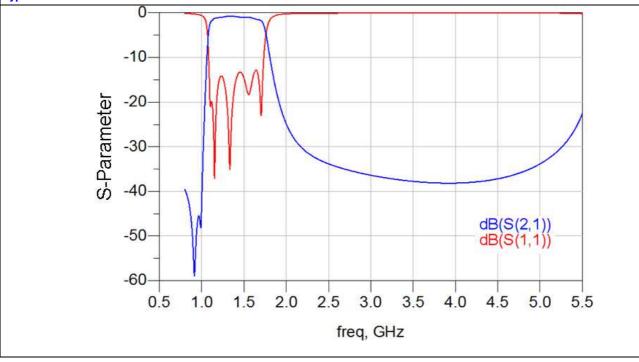
Figure	Symbol	Dimension (mm)
L	L	3.20 ± 0.20
	W	2.50 ± 0.20
≥ • 	Т	2.00 max.
•	А	0.95 ± 0.20
	В	0.60 ± 0.20
CDE	С	0.30 ± 0.15
	D	0.70 ± 0.15
ω;	E	1.20 ± 0.15
	F	2.00 ± 0.15



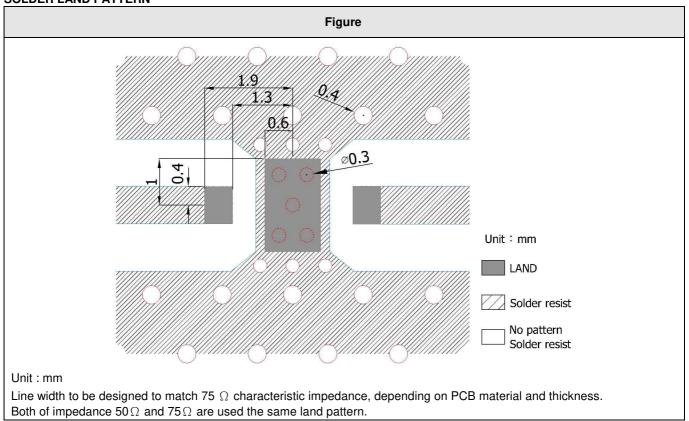
ELECTRICAL CHARACTERISTICS

RFBPF3225180C07B1U	Specification
Frequency range	1125 ~ 1675 MHz
Insertion Loss	1.80 dB max at +25°C
Insertion coss	2.00 dB max at -40°C ~ +85°C
VSWR	2.00 max
Port Impedance	75 Ω
	30 dB @ 5 ~ 864 MHz
Attenuation (min.)	34 dB @ 864 ~ 1002 MHz
	32 dB @ 2300 ~ 3000 MHz
Operation Temperature Range -40°C ~ +85°C	

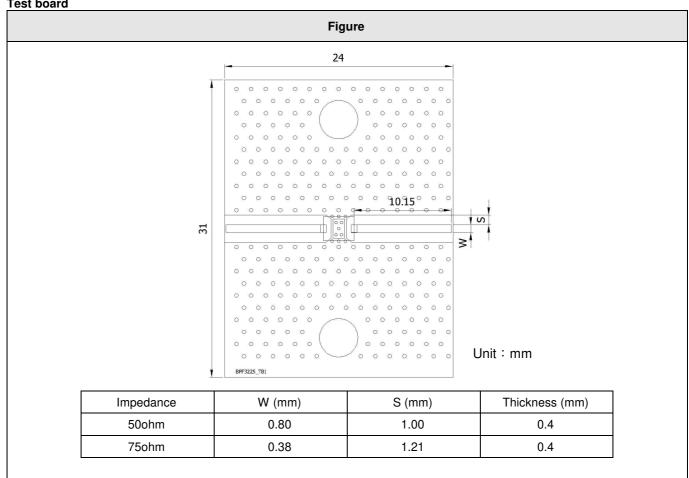




SOLDER LAND PATTERN



Test board





RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature : 235 \pm 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time: 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching	*Solder bath temperature: 260 ± 5°C	Loss of metallization on the edges of each
(Resistance to	*Leaching immersion time : 30 ± 0.5 sec	electrode shall not exceed 25%.
dissolution of	Solder : SN63A	electrode shall not exceed 25%.
metallization)		
IEC 60068-2-58		
Resistance to soldering heat	*Preheating temperature : 120~150℃,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
	Colday: Cm2Am0 FCv for land from	~ 85℃.
	Solder : Sn3Ag0.5Cu for lead-free	Loss of metallization on the edges of each
	Measurement to be made after keeping at	electrode shall not exceed 25%.
	room temperature for 24±2 hrs	
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044	*Test Surface: Rigid surface of concrete or	Electrical specification shall satisfy the
Customer's specification.	steel.	descriptions in electrical characteristics under
	*Times : 6 surfaces for each units ; 2 times	the operational temperature range within -40
	for each side.	~ 85℃.
	ioi cach side.	
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude: 1.5mm	Electrical specification shall satisfy the
	*Test times : 6hrs.(Two hrs each in three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
		~ 85℃.
Adhesive Strength	*Proceurizing force :	No nome disable demons of the second of the
of Termination	*Pressurizing force : 5N(≤0603) ; 10N(>0603)	No remarkable damage or removal of the termination.
JIS C 0051- 7.4.3		termination.
Bending test	*Test time: 10±1 sec	
JIS C 0051- 7.4.1	The middle part of substrate shall be	No mechanical damage.
	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85℃.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	

Approvar sneet		
Temperature cycle JIS C 0025	 30±3 minutes at -40°C±3°C, 10~15 minutes at room temperature, 30±3 minutes at +85°C±3°C, 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs 	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021 Humidity (steady conditions)	*Temperature: 85°C±2°C *Test duration: 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs *Humidity: 90% to 95% R.H. *Temperature: 40±2°C	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85℃. No mechanical damage. Electrical specification shall satisfy the
JIS C 0022	*Time: 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs \$\infty\$ 500hrs measuring the first data then 1000hrs data	descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Low temperature JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85℃.

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

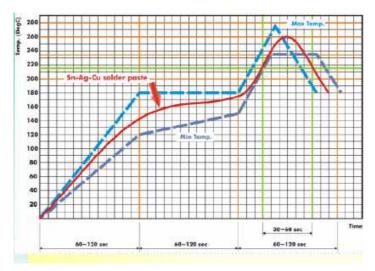


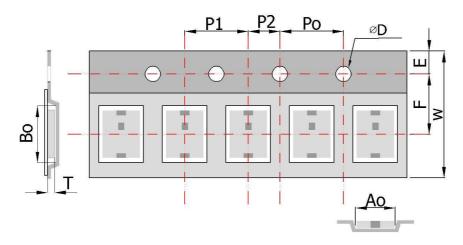
Fig 2. Infrared soldering profile

ORDERING CODE

RF	BPF	322518	0	С	07B1U
Walsin	Product Code	Dimension code	Unit of	Application	Specification
RF device	BPF:	Per 2 digits of Length,	dimension	C:1400MHz	Design code
	Band Pass Filter	Width, Thickness:	0 : 0.1 mm		
		e.g. :	1 : 1.0 mm		
		322518 =			
		Length 32,			
		Width 25,			
		Thickness 18			

Minimum Ordering Quantity: 2000 pcs per reel.

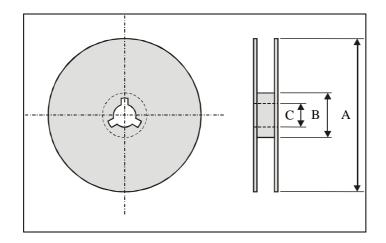
PACKAGING



Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	2.80 ± 0.10	3.46 ± 0.10	1.55 + 0.10	1.95 ± 0.10	8.0 ± 0.10
Index	Е	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10

Reel dimensions



Index	Α	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity: 2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : -10 to $+40^{\circ}$ C

Humidity: 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.